ROITHNER LASERTECHNIK GmbH
WIEDNER HAUPTSTRASSE 76 1040 VIENNA AUSTRIA
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PRELIMINARY

SMB1N-550H

- **Green High Power LED**
- **550 nm, 100 mW**
- **InGaAs chip, 1000 x 1000 µm**
- **PA9T SMD package**
- **Beam Angle: ± 65°**

RoHS COMPLIANT Pb-Free

Description

SMB1N-550H is a surface mount InGaN based high power green LED, with a typical peak wavelength of 550 nm and optical output power of 100 mW @ 350 mA. It comes in SMD package (PA9T) with silver plated soldering pads (lead free solderable), copper heat sink, and silicone resin molded flat window.

Maximum Ratings*

Parameter	Symbol	Values Min.	Values Max.	Unit
Power Dissipation	P_D		1200	mW
Forward Current	I_F		350	mA
Pulse Forward Current **	I_{FP}		500	mA
Reverse Voltage	U_F		5	V
Thermal Resistance	R_{THJA}		10	K/W
Junction Temperature	T_J		120	°C
Operating Temperature	T_{CASE}	- 40	+ 100	°C
Storage Temperature	T_{STG}	- 40	+ 100	°C
Lead Solder Temperature (t_{max}. 5s)	T_{SLD}		+ 250	°C

***** Operating close to or exceeding these parameters may damage the device
** duty cycle = 1 %, pulse width = 10 µs

Electro-Optical Characteristics (T_{CASE} = 25°C)

Parameter	Symbol	Conditions	Values Min.	Values Typ.	Values Max.	Unit
Peak Wavelength	λ_P	I_F=350 mA	540		560	nm
Half Width	λ_Δ	I_F=350 mA		35		nm
Forward Voltage	V_F	I_F=350 mA		2.7	3.4	V
	V_{FP}	I_{FP}=500 mA		2.9		
Total Radiated Power	P_O	I_F=350 mA	70	100		mW
		I_{FP}=500 mA		140		
Radiant Intensity	I_E	I_F=350 mA		33		mW/sr
		I_{FP}=500 mA		46		
Viewing Angle	$2\theta_{1/2}$	I_F=100 mA		130		deg.
Rise Time	t_r	I_F=350 mA		100		ns
Fall Time	t_f	I_F=350 mA		30		ns

* duty cycle = 1 %, pulse width = 10 µs

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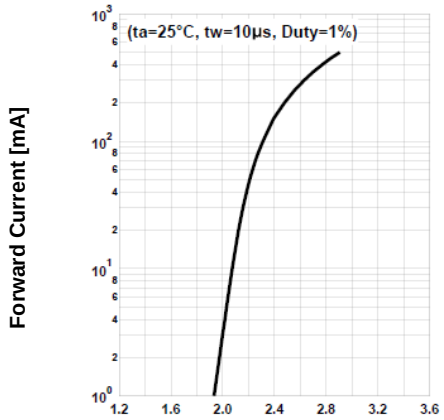
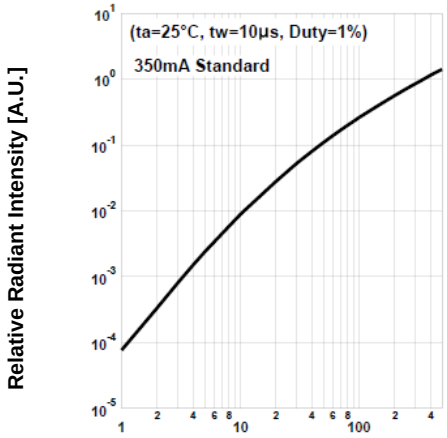
Typical Performance Curves

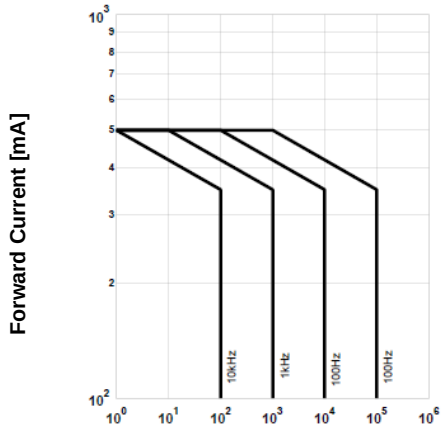
Forward Current vs. Forward Voltage



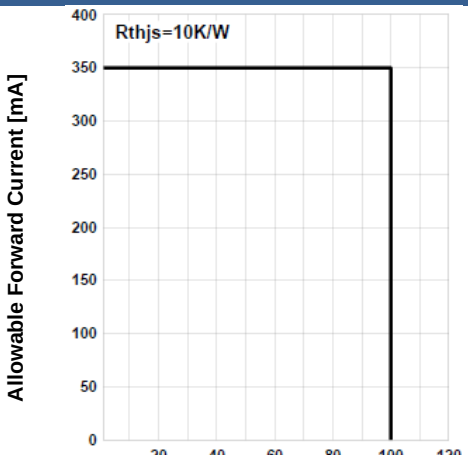
Relative Radiant Intensity vs. Forward Current



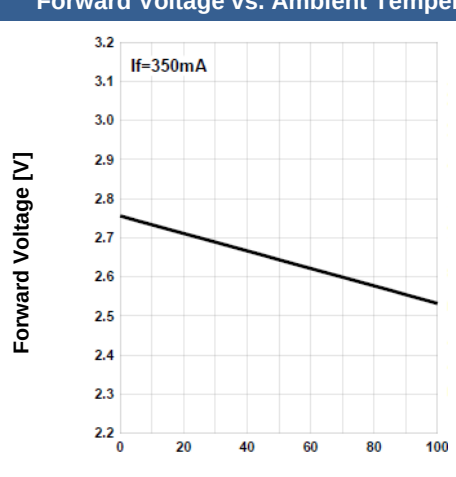
Forward Current vs. Pulse Duration



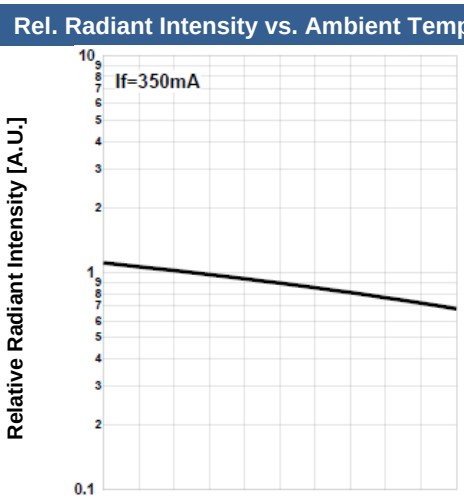
Allowed Forward Current vs. Amb. Temperature



Forward Voltage vs. Ambient Temperature



Rel. Radiant Intensity vs. Ambient Temperature



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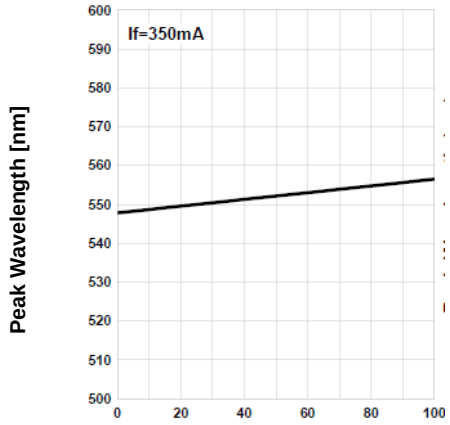
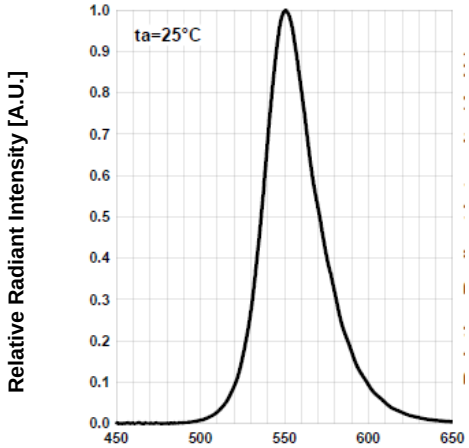
Typical Performance Curves

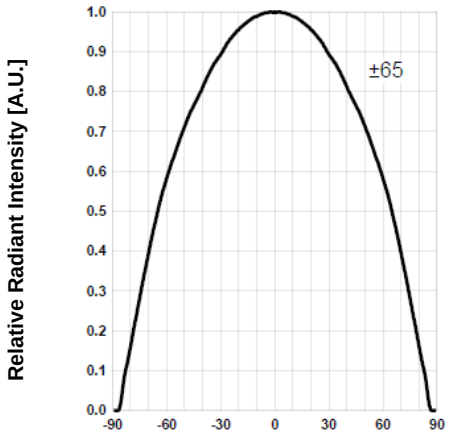
Peak Wavelength vs. Amb. Temp.



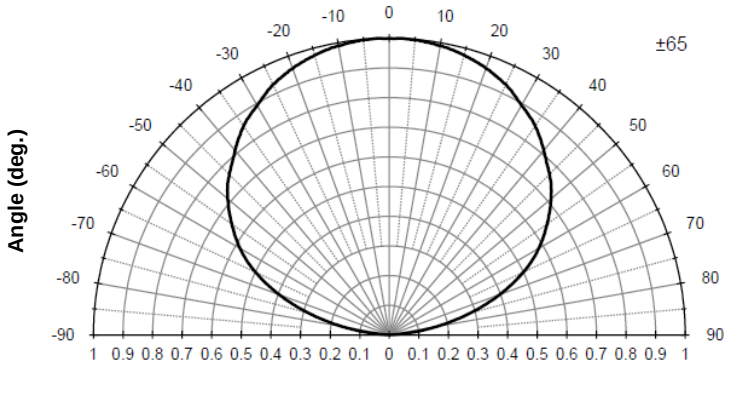
Relative Spectral Emission



Radiation Characteristics

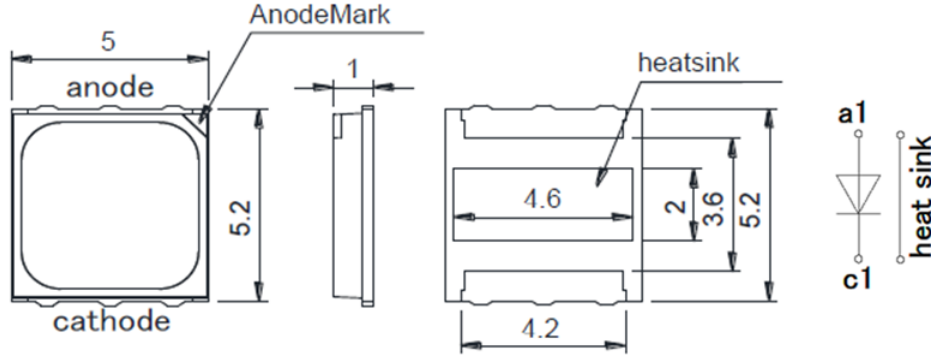


Radiation Characteristics



Outline Dimensions

PA9T



Lead	Function
Pin a1	Anode
Pin c1	Cathode

all dimensions in mm

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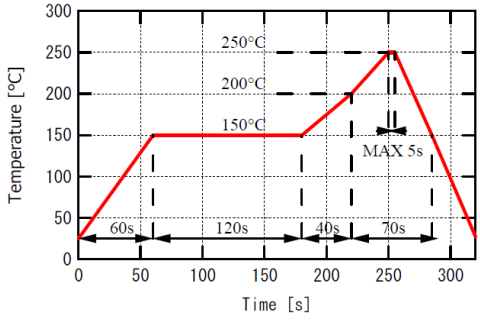
General Notes

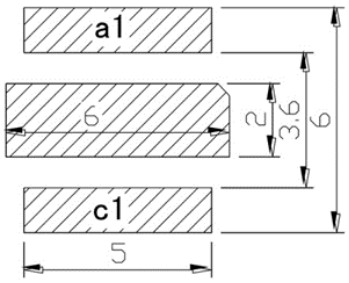
Soldering

- Do avoid overheating of the LED
- Do avoid electrostatic discharge (ESD)
- Do avoid mechanical stress, shock, and vibration
- Do only use non-corrosive flux
- Do not apply current to the LED until it has cooled down to room temperature after soldering

Recommended soldering conditions



Recommended soldering patterns



Unit: mm

Cleaning

- **Cleaning with isopropyl alcohol, propanol, or ethyl alcohol is recommended**
- DO NOT USE acetone, chloroseen, trichloroethylene, or MKS
- DO NOT USE ultrasonic cleaners

Static Electricity

- **LEDs are sensitive to electrostatic discharge (ESD)**.
- Precautions against ESD must be taken when handling or operating these LEDs
- Surge voltage or electrostatic discharge can result in complete failure of the LED.

Radiation

- During operation these LEDs do emit light, which **could be hazardous to skin and eyes**, and **may cause cancer**.
- Do avoid exposure to the emitted light. Protective glasses if needed
- It is further advised to attach a warning label on products/systems.

Operation

- **Do *only* operate LEDs with a current source.**
- Running these LEDs from a voltage source will result in complete failure of the device.
- Current of a LED is an exponential function of the voltage across it. Usage of current regulated drive circuits is mandatory.

Storage

- The **maximum shelf life** of LEDs in the originally sealed aluminum bag is **12 months**.
- Before opening the aluminum bag, please store it at **<30 ºC, <60 % RH**.
- After opening the aluminum bag, please solder the LEDs within **72 hours (floor life)** at **5 – 30 ºC, <50 % RH**.
- Put any unused, remaining LEDs and silica gel back in the same aluminum bag and then vacuum-seal the bag.
- It is recommended to keep the re-sealed bag in a desiccator at <30%RH.